- Very Low Power Consumption
- Power Dissipation With ±2-V Supplies 170 μW Typ
- Low Input Bias and Offset Currents
- Output Short-Circuit Protection
- Low Input Offset Voltage
- Internal Frequency Compensation
- Latch-Up-Free Operation
- Popular Dual Operational Amplifier Pinout

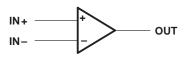
# TL022M IS NOT RECOMMENDED FOR NEW DESIGNS

#### description

The TL022 is a dual low-power operational amplifier designed to replace higher power devices in many applications without sacrificing system performance. High input impedance, low supply currents, and low equivalent input noise voltage over a wide range of operating supply voltages result in an extremely versatile operational amplifier for use in a variety of analog applications including battery-operated circuits. Internal frequency compensation, absence of latch-up, high slew rate, and output short-circuit protection assure ease of use.

TL022M . . . JG PACKAGE TL022C...D OR P PACKAGE (TOP VIEW) 8 🛮 V<sub>CC</sub> 10UT 7 1 20UT 1IN− 6 🛮 2IN-1IN+ 3 GND 5 1 2IN+ TL022M ... U PACKAGE (TOP VIEW) 10 ∏ NC NC 10UT[] 2 9 VCC+ 8 20UT 1IN−[ 3 7 2IN-1IN+[] 4 6 1 2IN+ V<sub>CC</sub> -

#### symbol (each amplifier)



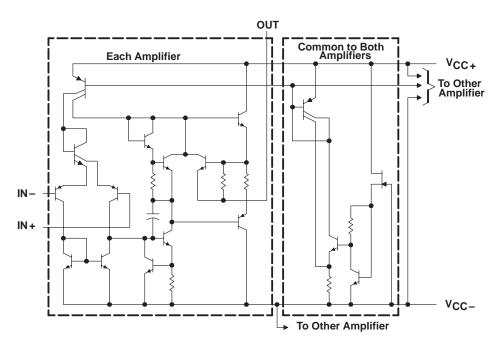
The TL022C is characterized for operation from 0°C to 70°C. The TL022M is characterized for operation over the full military temperature range of –55°C to 125°C.

#### **AVAILABLE OPTIONS**

|                | Viemay                         |                      | PAC                 | KAGE               |                          |  |
|----------------|--------------------------------|----------------------|---------------------|--------------------|--------------------------|--|
| TA             | V <sub>IO</sub> max<br>AT 25°C | SMALL OUTLINE<br>(D) | CERAMIC DIP<br>(JG) | PLASTIC DIP<br>(P) | CERAMIC FLAT PACK<br>(U) |  |
| 0°C to 70°C    | 5 mV                           | TL022CD              | _                   | TL022CP            | _                        |  |
| -55°C to 125°C | 5 mV                           | _                    | TL022MJG            | _                  | TL022MU                  |  |

The D package is available taped and reeled. Add the suffix R to the device type (i.e. TL022CDR).

#### schematic



#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

|  |                 | TL022C     | TL022M     | UNIT |
|--|-----------------|------------|------------|------|
| Supply voltage, V <sub>CC+</sub> (see Note 1)                |                 | 18         | 22         | V    |
| Supply voltage, V <sub>CC</sub> – (see Note 1)               |                 | -18        | -22        | V    |
| Differential input voltage (see Note 2)                      |                 | ±30        | ±30        | V    |
| Input voltage (any input, see Notes 1 and 3)                 | ±15             | ±15        | V          |      |
| Duration of output short circuit (see Note 4)                | unlimited       | unlimited  |            |      |
| Continuous total dissipation                                 |                 | See Diss   | Table      |      |
| Operating free-air temperature range                         |                 | 0 to 70    | -55 to 125 | °C   |
| Storage temperature range                                    |                 | -65 to 150 | -65 to 150 | °C   |
| Lead temperature 1,6 mm (1/16 inch) from case for 60 seconds | JG or U package |            | 300        | °C   |
| Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds | D or P package  | 260        |            | °C   |

NOTES: 1. All voltage values, unless otherwise noted, are with respect to the midpoint between  $V_{CC+}$  and  $V_{CC-}$ .

- 2. Differential voltages are at IN+ with respect to IN-.
- 3. The magnitude of the input voltage must never exceed the magnitude of the supply voltage or 15 V, whichever is less.
- 4. The output may be shorted to ground or either power supply. For the TL022M only, the unlimited duration of the short circuit applies at (or below) 125°C case temperature or 75°C free-air temperature.

#### **DISSIPATION RATING TABLE**

| PACKAGE | $T_{\mbox{A}} \le 25^{\circ}\mbox{C}$ POWER RATING | DERATING<br>FACTOR | DERATE<br>ABOVE T <sub>A</sub> | T <sub>A</sub> = 70°C<br>POWER RATING | T <sub>A</sub> = 125°C<br>POWER RATING |
|---------|--|--------------------|--------------------------------|---------------------------------------|--|
| D       | 680 mW   | 5.8 mW/°C          | 33°C                           | 464 mW                                | _                                      |
| JG      | 680 mW   | 8.4 mW/°C          | 69°C                           | 672 mW                                | 210 mW                                 |
| Р       | 680 mW   | 8.0 mW/°C          | 65°C                           | 640 mW                                | _                                      |
| U       | 675 mW   | 5.4 mW/°C          | 25°C                           | 432 mW                                | 135 mW                                 |



SLOS076 - SEPTEMBER 1973 - REVISED SEPTEMBER 1990

#### recommended operating conditions

|                                   | MIN | MAX | UNIT |
|-----------------------------------|-----|-----|------|
| Supply voltage, V <sub>CC+</sub>  | 5   | 15  | V    |
| Supply voltage, V <sub>CC</sub> _ | -5  | -15 | V    |

## electrical characteristics at specified free-air temperature, $V_{CC\pm}$ = $\pm 15$ V (unless otherwise noted)

|                 | DADAMETED                      |  |            | ٦   | ΓL022C |     | TL022M |     |     |       |  |
|-----------------|--------------------------------|--|------------|-----|--------|-----|--------|-----|-----|-------|--|
|                 | PARAMETER                      | TEST CONDITION                                   | IST        | MIN | TYP    | MAX | MIN    | TYP | MAX | UNIT  |  |
| \/              | land offert veltage            | $V_{O} = 0$ ,                                    | 25°C       |     | 1      | 5   |        | 1   | 5   | \/    |  |
| VIO             | Input offset voltage           | $R_S = 50 \Omega$                                | Full range |     |        | 7.5 |        |     | 6   | mV    |  |
| li o            | Input offset current           | V <sub>O</sub> = 0                               | 25°C       |     | 15     | 80  |        | 5   | 40  | nA    |  |
| lio             | input onset current            | VO = 0   | Full range |     |        | 200 |        |     | 100 | IIA   |  |
| I <sub>IB</sub> | Input bias current             | V <sub>O</sub> = 0                               | 25°C       |     | 100    | 250 |        | 50  | 100 | nA    |  |
| אוי             | input bias current             | 10-0   | Full range |     |        | 400 |        |     | 250 | 11/1  |  |
| VICR            | Common-mode input              |  | 25°C       | ±12 | ±13    |     | ±12    | ±13 |     | V     |  |
| VICR            | voltage range                  |  | Full range | ±12 |        |     | ±12    |     |     | V     |  |
| VO(PP)          | Maximum peak-to-peak           | $R_L = 10 \text{ k}\Omega$                       | 25°C       | 20  | 26     |     | 20     | 26  |     | V     |  |
| VO(PP)          | output voltage swing           | $R_L \ge 10 \text{ k}\Omega$                     | Full range | 20  |        |     | 20     |     |     | V     |  |
| AVD             | Large-signal differential      | R <sub>L</sub> ≥ 10 kΩ,                          | 25°C       | 60  | 80     |     | 72     | 86  |     | dB    |  |
| ~VD             | voltage amplification          | V <sub>O</sub> = ±10 V                           | Full range | 60  |        |     | 66     |     |     | GD.   |  |
| B <sub>1</sub>  | Unity-gain bandwidth           |  | 25°C       |     | 0.5    |     |        | 0.5 |     | MHz   |  |
| CMRR            | Common-mode rejection          | V <sub>IC</sub> = V <sub>ICR</sub> min,          | 25°C       | 60  | 72     |     | 60     | 72  |     | dB    |  |
| Civilata        | ratio                          | $R_S = 50 \Omega$                                | Full range | 60  |        |     | 60     |     |     | uВ    |  |
| ksvs            | Supply voltage sensitivity     | $V_{CC} = \pm 9 \text{ V to } \pm 15 \text{ V},$ | 25°C       |     | 30     | 200 |        | 30  | 150 | μV/V  |  |
| NSVS            | (ΔΛΙΟ/ΦΛСС)                    | $R_S = 50 \Omega$                                | Full range |     |        | 200 |        |     | 150 | μν/ν  |  |
| V <sub>n</sub>  | Equivalent input noise voltage | $A_{VD} = 20 \text{ dB},$<br>B = 1 Hz, f = 1 kHz | 25°C       |     | 50     |     |        | 50  |     | nV/Hz |  |
| los             | Short-circuit output current   |  | 25°C       |     | ±6     |     |        | ±6  |     | mA    |  |
| loo             | Supply current (both           | V <sub>O</sub> = 0, No load                      | 25°C       |     | 130    | 250 |        | 130 | 250 | Δ     |  |
| ICC             | amplifiers)                    | VO = 0, 140 10au                                 | Full range |     |        | 250 |        |     | 250 | μΑ    |  |
| PD              | Total dissipation              | $V_O = 0$ , No load                              | 25°C       |     | 3.9    | 7.5 |        | 3.9 | 6   | mW    |  |
| . ט             | (both amplifiers)              | 140 load   | Full range |     |        | 7.5 |        |     | 6   | 11177 |  |

<sup>†</sup> All characteristics are measured under open-loop conditions with zero common-mode input voltage unless otherwise specified. Full range for TL022C is 0°C to 70°C and for TL022M is -55°C to 125°C.

## operating characteristics, $V_{CC\pm}$ = $\pm 15$ V, $T_A$ = $25^{\circ}C$

|                | PARAMETER               |                        | MIN                            | TYP                      | MAX          | UNIT |     |  |      |
|----------------|-------------------------|------------------------|--------------------------------|--------------------------|--------------|------|-----|--|------|
| t <sub>r</sub> | Rise time               | Vı = 20 mV.            | P 10 kO                        | C 100 pE                 | Soo Figuro 1 |      | 0.3 |  | μs   |
|                | Overshoot factor        | V  = 20 IIIV,          | $K_{\perp} = 10 \text{ K}_{2}$ | $C_{L}$ = 100 pF,        | See Figure 1 |      | 5%  |  |      |
| SR             | Slew rate at unity gain | V <sub>I</sub> = 10 V, | $R_L = 10 \text{ k}\Omega$ ,   | C <sub>L</sub> = 100 pF, | See Figure 1 |      | 0.5 |  | V/μs |



#### PARAMETER MEASUREMENT INFORMATION

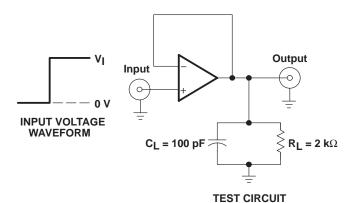


Figure 1. Rise Time, Overshoot Factor, and Slew Rate

#### **TYPICAL CHARACTERISTICS**

# TOTAL POWER DISSIPATION vs

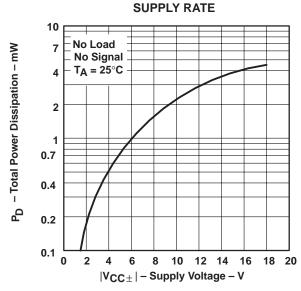


Figure 2

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#### **PACKAGING INFORMATION**

| Orderable Device | Status (1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan     | Lead finish/<br>Ball material | MSL Peak Temp      | Op Temp (°C) | Device Marking<br>(4/5) | Samples |
|------------------|------------|--------------|--------------------|------|----------------|--------------|-------------------------------|--------------------|--------------|-------------------------|---------|
| TL022CD          | LIFEBUY    | SOIC         | D                  | 8    | 75             | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | 0 to 70      | TL022C                  |         |
| TL022CDR         | ACTIVE     | SOIC         | D                  | 8    | 2500           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | 0 to 70      | TL022C                  | Samples |
| TL022CDR         | ACTIVE     | SOIC         | D                  | 8    | 2500           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | 0 to 70      | TL022C                  | Samples |
| TL022CDR         | ACTIVE     | SOIC         | D                  | 8    | 2500           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | 0 to 70      | TL022C                  | Samples |
| TL022CDRG4       | LIFEBUY    | SOIC         | D                  | 8    | 2500           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | 0 to 70      | TL022C                  |         |
| TL022CDRG4       | LIFEBUY    | SOIC         | D                  | 8    | 2500           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | 0 to 70      | TL022C                  |         |
| TL022CDRG4       | LIFEBUY    | SOIC         | D                  | 8    | 2500           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | 0 to 70      | TL022C                  |         |
| TL022CP          | ACTIVE     | PDIP         | Р                  | 8    | 50             | RoHS & Green | NIPDAU                        | N / A for Pkg Type | 0 to 70      | TL022CP                 | Samples |
| TL022CP          | ACTIVE     | PDIP         | Р                  | 8    | 50             | RoHS & Green | NIPDAU                        | N / A for Pkg Type | 0 to 70      | TL022CP                 | Samples |
| TL022CP          | ACTIVE     | PDIP         | Р                  | 8    | 50             | RoHS & Green | NIPDAU                        | N / A for Pkg Type | 0 to 70      | TL022CP                 | Samples |
| TL022CPSR        | ACTIVE     | SO           | PS                 | 8    | 2000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | 0 to 70      | T022                    | Samples |
| TL022CPSR        | ACTIVE     | SO           | PS                 | 8    | 2000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | 0 to 70      | T022                    | Samples |
| TL022CPSR        | ACTIVE     | SO           | PS                 | 8    | 2000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | 0 to 70      | T022                    | Samples |
| TL022CPSRG4      | ACTIVE     | so           | PS                 | 8    | 2000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | 0 to 70      | T022                    | Samples |
| TL022CPSRG4      | ACTIVE     | so           | PS                 | 8    | 2000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | 0 to 70      | T022                    | Samples |
| TL022CPSRG4      | ACTIVE     | SO           | PS                 | 8    | 2000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | 0 to 70      | T022                    | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design. PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.



#### PACKAGE OPTION ADDENDUM

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(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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## **PACKAGE MATERIALS INFORMATION**

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#### TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width     |
|----|---|
| В0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

|   | Device    | U    | Package<br>Drawing |   | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|---|-----------|------|--------------------|---|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
|   | TL022CDR  | SOIC | D                  | 8 | 2500 | 330.0                    | 12.4                     | 6.4        | 5.2        | 2.1        | 8.0        | 12.0      | Q1               |
| L | TL022CPSR | SO   | PS                 | 8 | 2000 | 330.0                    | 16.4                     | 8.35       | 6.6        | 2.4        | 12.0       | 16.0      | Q1               |

**PACKAGE MATERIALS INFORMATION** 

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#### \*All dimensions are nominal

| Device    | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-----------|--------------|-----------------|------|------|-------------|------------|-------------|
| TL022CDR  | SOIC         | D               | 8    | 2500 | 340.5       | 336.1      | 25.0        |
| TL022CPSR | SO           | PS              | 8    | 2000 | 356.0       | 356.0      | 35.0        |

## **PACKAGE MATERIALS INFORMATION**

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#### **TUBE**



#### \*All dimensions are nominal

| Device  | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
|---------|--------------|--------------|------|-----|--------|--------|--------|--------|
| TL022CD | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TL022CP | Р            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |



SMALL OUTLINE INTEGRATED CIRCUIT



#### NOTES:

- 1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
- 4. This dimension does not include interlead flash.
- 5. Reference JEDEC registration MS-012, variation AA.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE INTEGRATED CIRCUIT



#### NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.





NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



## PS (R-PDSO-G8)

## PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



## P (R-PDIP-T8)

## PLASTIC DUAL-IN-LINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001 variation BA.



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